

APFA3010SEEZGQBDC

3.0 x 1.0 mm Right Angle SMD Chip LED Lamp



DESCRIPTIONS

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- The Blue source color devices are made with InGaN on Sapphire Light Emitting Diode
- · Electrostatic discharge and power surge could Damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- 3.0 x 1.5 x 1.0 mm right angle SMD LED, 1.0mm thickness
- · Low power consumption
- · Wide viewing angle
- · Ideal for backlight and indicator
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- · Tinned pads for improved solderability
- · RoHS compliant

APPLICATIONS

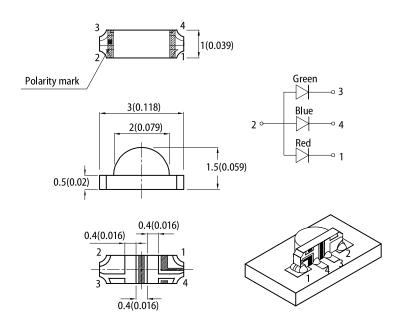
- Backlight
- · Status indicator
- · Home and smart appliances
- Wearable and portable devices
- · Healthcare applications

ATTENTION

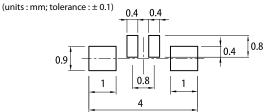
Observe precautions for handling electrostatic discharge sensitive devices



PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN



- 1. All dimensions are in millimeters (inches)
- Tolerance is ±0.2(0.008") unless otherwise noted.
 The specifications, characteristics and technical data described in the datasheet are subject to
- change without prior notice.

 The device has a single mounting surface. The device must be mounted according to the specifications

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 20mA [2]		Viewing Angle [1]	
			Min.	Тур.	201/2	
APFA3010SEEZGQBDC	■ Hyper Red (AlGaInP)		80	140		
	■ Green (InGaN)	Water Clear	300	500	150°	
	■ Blue (InGaN)		40	70		

Notes.
1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: +/-15%.

3. Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Dovementor	Complete al	Funithing Colon	Value		11-4	
Parameter	Symbol	Emitting Color	Тур.	Max.	Unit	
Wavelength at Peak Emission I _F = 20mA	λ_{peak}	Hyper Red Green Blue	630 515 460	-	nm	
Dominant Wavelength I _F = 20mA	λ_{dom} [1]	Hyper Red Green Blue	621 525 465	-	nm	
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Hyper Red Green Blue	20 35 25	-	nm	
Capacitance	С	Hyper Red Green Blue	25 45 100	-	pF	
Forward Voltage I _F = 20mA	V _F ^[2]	Hyper Red Green Blue	2.0 3.3 3.3	2.5 4.1 4.0	V	
Reverse Current (V _R = 5V)	I _R	Hyper Red Green Blue	-	10 50 50	uA	

Notes:

Notes:

1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd: ±1nm.)

2. Forward voltage: ±0.1V.

3. Wavelength value is traceable to CIE127-2007 standards.

4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

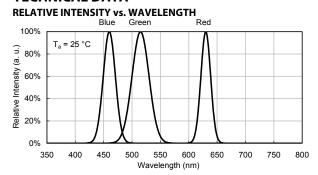
B	Symbol	Value			
Parameter		Hyper Red	Green	Blue	Unit
Power Dissipation	P_D	75	102.5	120	mW
Reverse Voltage	V _R	5	5	5	V
Junction Temperature	T _j	115	115	115	°C
Operating Temperature	T _{op}	-40 to +85			°C
Storage Temperature	T _{stg}	-40 to +85			°C
DC Forward Current	I _F	30	25	30	mA
Peak Forward Current	I _{FM} ^[1]	195	150	150	mA
Electrostatic Discharge Threshold (HBM)	-	3000	450	250	V

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

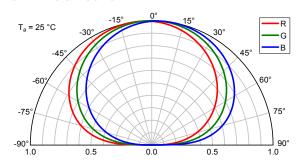




TECHNICAL DATA

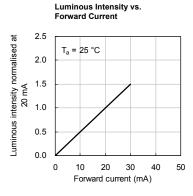


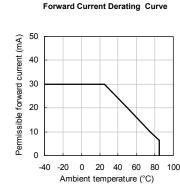
SPATIAL DISTRIBUTION

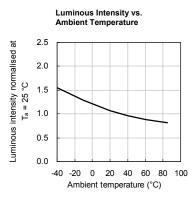


HYPER RED

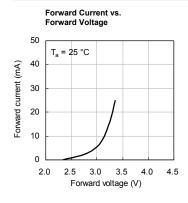
Forward Current vs. Forward Voltage 50 T_a = 25 °C 40 Forward current (mA) 30 20 10 0 1.5 1.7 1.9 2.1 2.3 Forward voltage (V)

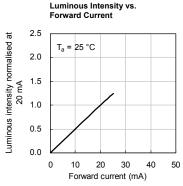


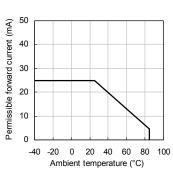




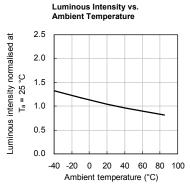
GREEN



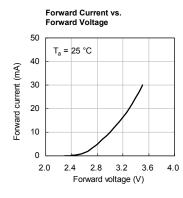


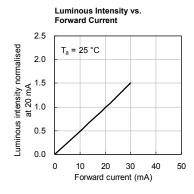


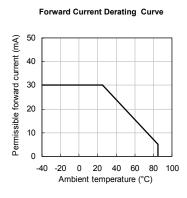
Forward Current Derating Curve

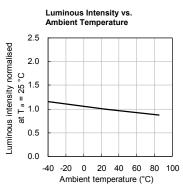


BLUE





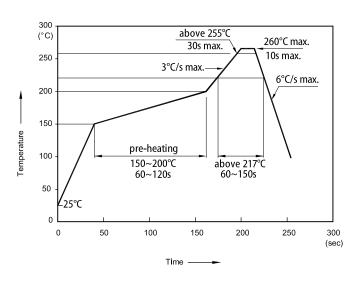






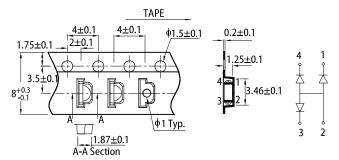
TECHNICAL DATA

REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

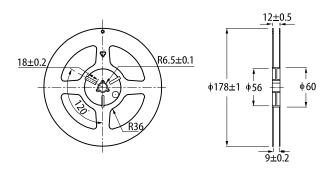


- 1. Don't cause stress to the LEDs while it is exposed to high temperature.
 2. The maximum number of reflow soldering passes is 2 times.
 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

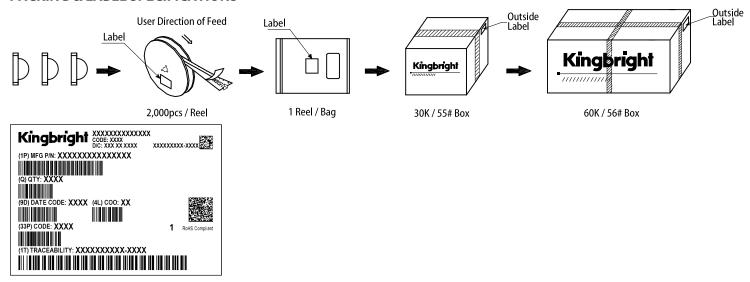
TAPE SPECIFICATIONS (units:mm)



REEL DIMENSION (units: mm)



PACKING & LABEL SPECIFICATIONS



PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

 The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening
- liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.

 The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright
- All design applications should refer to Kingbright application notes available at http://www.Kingbright

